





Recommended Soldering Pattern

## **Electrical:**

Impedance: 50 ohm

Voltage Rating: 250 V rms MIN. (depending on cable)

Insulator Resistance :  $\geq 1 \text{ G}\Omega$ 

Dielectric Withstanding Voltage : 750 V rms . Contact Resistance : Center Contact  $\leq$  5 m $\Omega$ . Outer Contact  $\leq$  2.5 m $\Omega$ 

Туре	Dimensions								
	A	В	C	D	а	b	C		
A0	0.96	1.60	5.08	11.5	1.2	1.7	4.75		
P0	1.00	1.40	6	7.6	1.2	1.6	4.6		

## **Mechanical:**

Mating : Snap-on Coupling. Engagement Force :  $\leq 14.2$  lbs Disengagement Force :  $1.8\sim14.2$  lbs

## **Environmental:**

Temperature Range: -65°C to 165°C

Corrosion (Salt Spray): MIL-STD-202, Method 101,

Cond. B

Thermal Shock : MIL-STD-202, Method 107, Cond. B Mechanical : MIL-STD-202, Method 213, Cond. B

Vibration: MIL-STD-202, Method 204, Cond. D

## Notes:

- 1. The overall contour may be slightly changed per terminating with different cable and we reserve right to change it without notice.
- 2. Any changes for interface dimensions are strictly prohibited.
- 3. The Material and plating are in various options per customer's request.
- 4. A complete information for connectors is available upon request.

Scale		bbr.	Date		Rev.	
NTS		ST 2019/0		7/19	В	
Tolerances .X ±0	: ).2	$\oplus \Box$				
.XX ±0		All Dimensions in mm (Unless Otherwise Specified)				
Drawn		Chec	ked	Approved		
Mark		Ryan		G.	Sun	
2019 07 19		2019 07 19		201	9/07/19	

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Customer P/N: Nil

DWG.NO. SB210

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TITLE

SMB S/T Jack, SMT Type



